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PATENT ABSTRACTS OF JAPAN

(11) Publication number : 03-220911

(43) Date of publication of application : 30.09.1991

(51)Int.Cl. H03H 9/25

(21)Application number : 02-017012 (71)Applicant : FUJITSU LTD

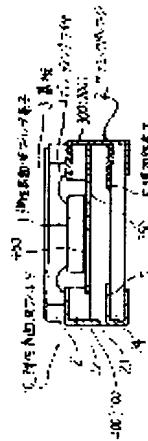
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(54) SURFACE ACOUSTIC WAVE FILTER

(57) Abstract:

PURPOSE: To contrive miniaturization by providing an impedance matching circuit composed of plural film circuit elements on the inner and outer exposure faces of a package or between the layers of the ceramic package.

CONSTITUTION: An impedance matching circuit composed of plural film circuit elements 5 is provided on the inner and outer exposure faces of the package 2 or between the layers of the ceramic package 2 to constitute this surface acoustic wave filter 10. Since the impedance matching circuit is integrated with the ceramic package 2 with the plural film circuit elements 5 provided between the layers of the ceramic package 2 or the inner and outer exposure faces of the package 2 in such a manner, it is not required to add another impedance matching circuit at the outside to constitute the filter circuit and the entire size of the filter circuit 10 is miniaturized.



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[Date of request for examination]

[Date of sending the examiner's decision of

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[rejection]

[Kind of final disposal of application other than the examiner's decision of rejection or application converted registration]

[Date of final disposal for application]

[Patent number]

[Date of registration]

[Number of appeal against examiner's decision of rejection]

[Date of requesting appeal against examiner's decision of rejection]

[Date of extinction of right]